



SSC65TR50GT2

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Trench FSII Fast IGBT

➤ Features

V_{CES}	V_{GES}	I_C
650V	$\pm 20V$	100A@25°C
		50A@100°C

➤ Description

- High efficiency for inverters.
- High ruggedness performance.
- RoHS compliant.
- 5μs short circuit capability.

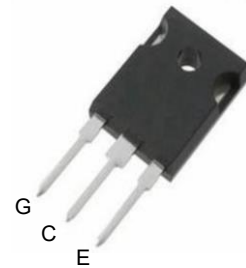
➤ Applications

- Welding Machines
- PFC Circuits

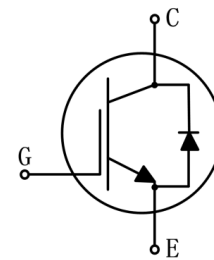
➤ Ordering Information

Device	Package	Shipping
SSC65TR50GT2	TO247-3L	30/Tube

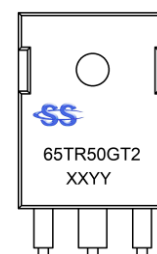
➤ Pin Configuration



TO247-3L (Top View)



Pin Configuration



Marking

(XYYY: Internal Traceability Code)



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➤ **Absolute Maximum Ratings**($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V_{CES}	Collector-Emitter Voltage		650	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Collector Current	$T_C=25^{\circ}\text{C}$	100	A
		$T_C=100^{\circ}\text{C}$	50	
I_{Cpuls}	Pulsed Collector Current, t_p limited by T_{Jmax}		200	A
P_D	Power Dissipation	$T_A=25^{\circ}\text{C}$	457	W
		$T_A=100^{\circ}\text{C}$	230	
T_J	Operating Junction and Storage Temperature Range		$-55\sim+150$	$^{\circ}\text{C}$
T_{STG}	Operating Junction and Storage Temperature Range		$-55\sim+150$	$^{\circ}\text{C}$
tsc	Short circuit withstand time		5	μs

➤ **Thermal Resistance Ratings**($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Thermal resistance, junction to ambient	40	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Thermal resistance, junction to case for IGBT	0.28	
$R_{\theta JC}$	Thermal resistance, junction to case for Diode	0.45	



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➤ Electronics Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$V_{GE}=0V, I_C=0.25mA$	650			V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0V, V_{CE}=650V, T_J=25^{\circ}C$			50	μA
		$V_{GE}=0V, V_{CE}=650V, T_J=150^{\circ}C$			1	mA
$I_{GES(F)}$	Gate to Emitter Forward Leakage	$V_{GE}=+20V, V_{CE}=0V$			100	nA
$I_{GES(R)}$	Gate to Emitter Reverse Leakage	$V_{GE}=-20V, V_{CE}=0V$			-100	nA
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=50A, V_{GE}=15V, T_J=25^{\circ}C$		1.75	2.1	V
		$I_C=50A, V_{GE}=15V, T_J=125^{\circ}C$		2.0		V
		$I_C=50A, V_{GE}=15V, T_J=150^{\circ}C$		2.1		V
$V_{GE(th)}$	Gate Threshold Voltage	$I_C=1mA, V_{CE}=V_{GE}$		4.8		V
G_{FS}	Transconductance	$V_{CE}=20V, I_C=50A$		19		S
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V, f=1MHz, T_J=25^{\circ}C$		4587		pF
C_{oes}	Output Capacitance			99		
C_{res}	Reverse Transfer Capacitance			33		
$T_{D(ON)}$	Turn-on delay time	$T_J=25^{\circ}C, V_{CC}=400V, I_C=32A, V_{GE}=0/15V, R_g=15\Omega$		51		ns
T_r	Rise time			37		
$T_{D(OFF)}$	Turn-off delay time			244		
T_f	Fall time			13		
E_{on}	Turn-On Switching Loss	Inductive Load		1.05		mJ
E_{off}	Turn-Off Switching Loss			0.30		
E_{ts}	Total Switching Loss			1.35		
$T_{D(ON)}$	Turn-on delay time	$T_J=150^{\circ}C, V_{CC}=400V, I_C=32A, V_{GE}=0/15V, R_g=15\Omega$		47		ns
T_r	Rise time			40		
$T_{D(OFF)}$	Turn-off delay time			273		
T_f	Fall time			20		
E_{on}	Turn-On Switching Loss	Inductive Load		1.16		mJ
E_{off}	Turn-Off Switching Loss			0.46		
E_{ts}	Total Switching Loss			1.62		
Q_G	Total Gate Charge	$V_{CC}=300V, I_C=50A, V_{GE}=0/15V$		149		nC
Q_{GE}	Gate to Emitter Charge			29		
Q_{GC}	Gate to Collector Charge			27		



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➤ **Electrical Characteristics of Diode ($T_{vj}=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VF	Diode forward voltage	$I_F=30\text{A}$, $T_{vj}=25^{\circ}\text{C}$		1.27		V
Trr	Diode reverse recovery time	$V_R=400\text{V}$ $I_F=30\text{A}$ $diF/dt=400\text{A}/\mu\text{s}$ $T_{vj}=25^{\circ}\text{C}$		130		ns
Irrm	Diode peak reverse recovery current			11		A
Qrr	Diode reverse recovery charge			0.6		nC



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➤ Typical Performance Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

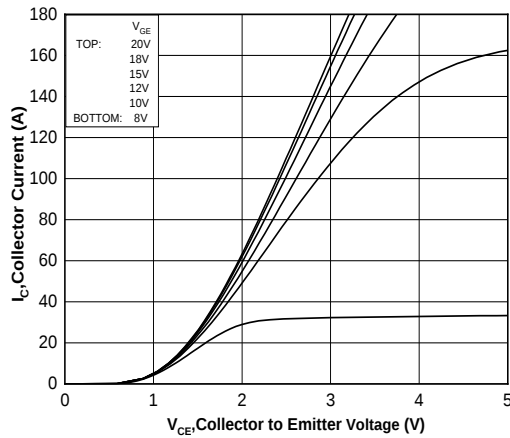


Figure 1. Output Characteristics($T_J=25^\circ\text{C}$)

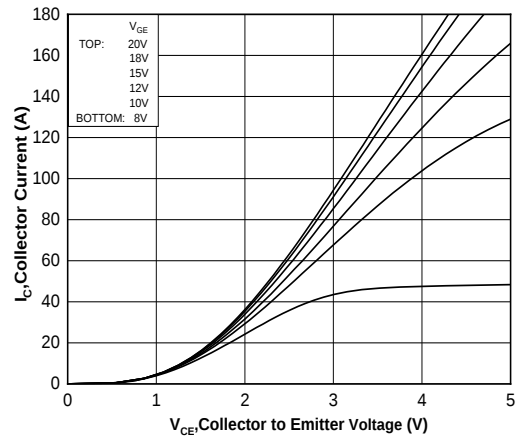


Figure 2. Output Characteristics($T_J=150^\circ\text{C}$)

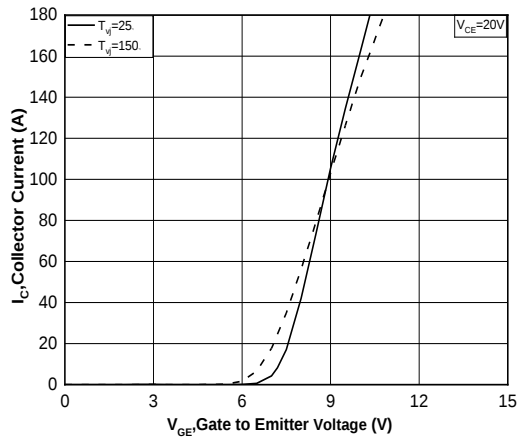


Figure 3. Typical transfer characteristic ($T_J=25^\circ\text{C}$)

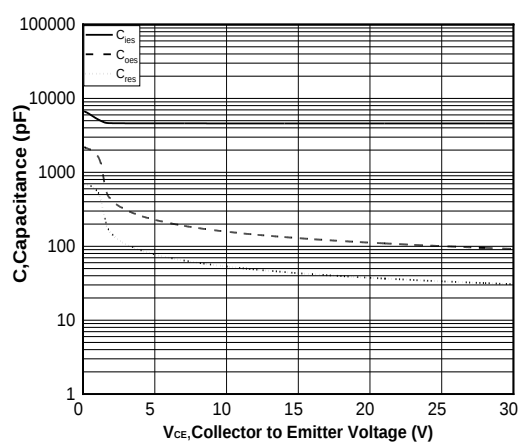


Figure 4. Capacitance characteristic
($V_{GE}=0\text{V}$, $f=1\text{MHz}$)

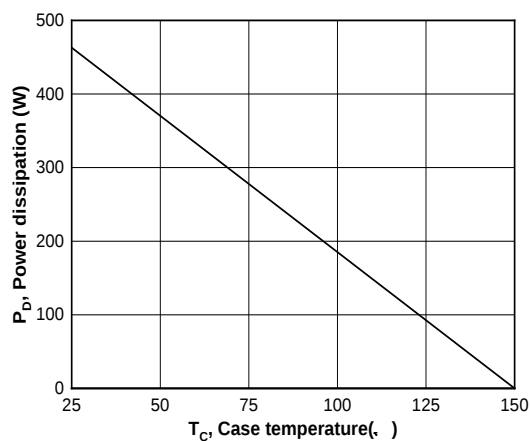


Figure 5. Power dissipation as a function of case temperature ($T_J \leq 150^\circ\text{C}$)

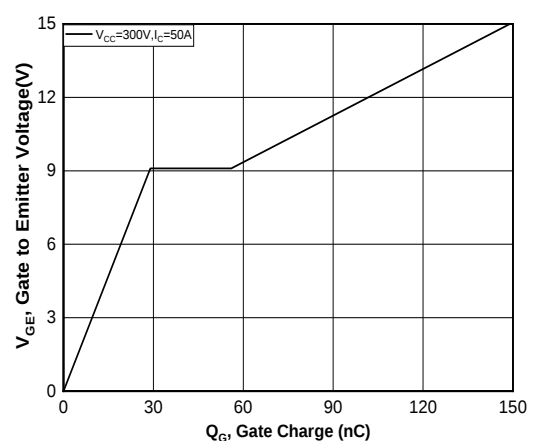


Figure 6. Typical gate charge ($I_C=50\text{A}$)



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➤ Typical Performance Characteristics (T_{vj}=25°C unless otherwise noted)

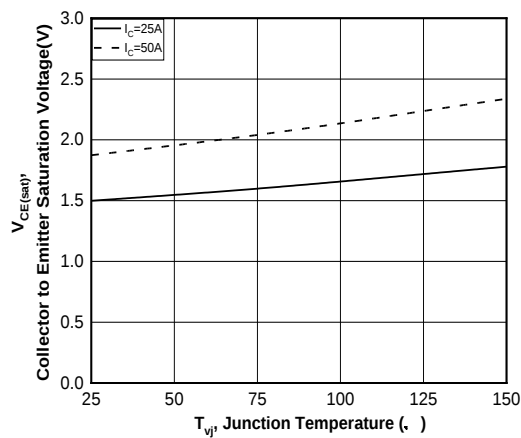


Figure 7. V_{CE(SAT)} as a function of junction temperature (V_{GE}=15V)

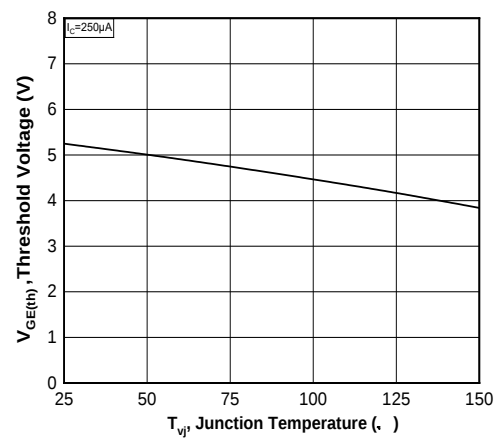


Figure 8. V_{GE(TH)} as a function of junction temperature (I_C=250μA)

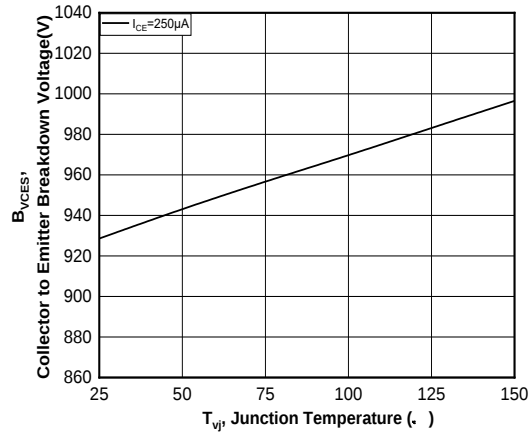


Figure 9. BV_{CES} as a function of junction temperature (I_{CE}=250μA)

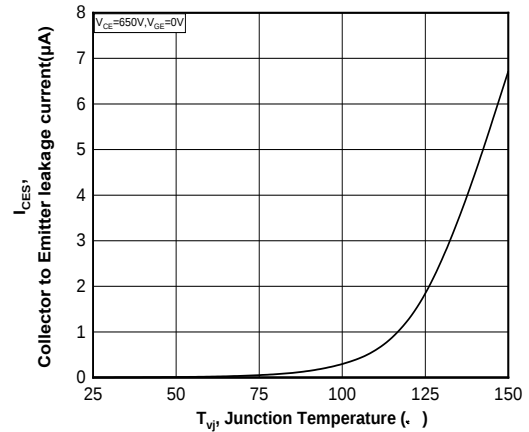


Figure 10. I_{CES} leakage current as a function of junction temperature

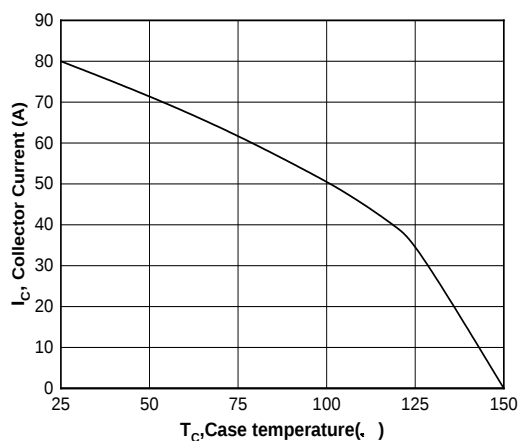


Figure 11. Collector current as a function of case temperature (V_{GE}≥15V, T_J≤150°C)

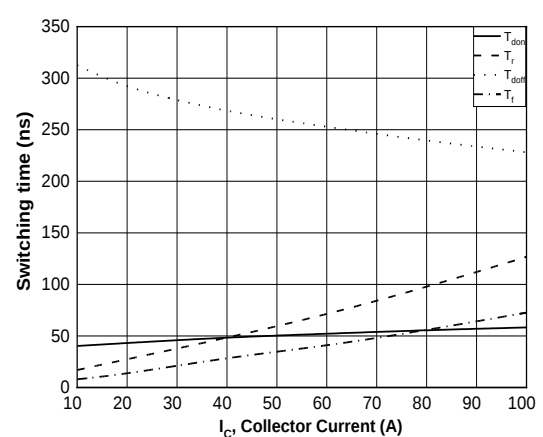


Figure 12. Typical switching times as a function of collector current (T_J=150°C, V_{CE}=400V, R_{G(on)}=R_{G(off)}=15Ω, V_{GE}=0/15V)



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➤ Typical Performance Characteristics (T_{vj}=25°C unless otherwise noted)

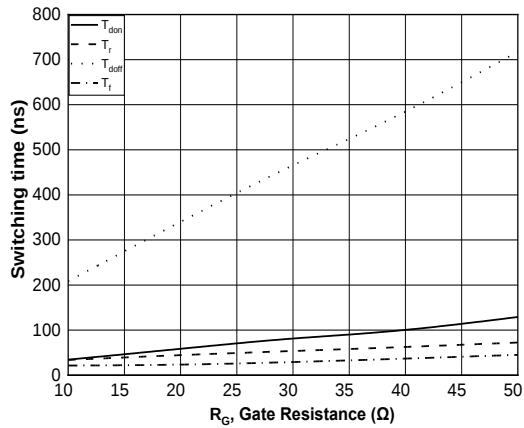


Figure 13. Typical switching times as a function of gate resistance (T_J=150°C, V_{CE}=400V, I_C=32A, V_{GE}=0/15V)

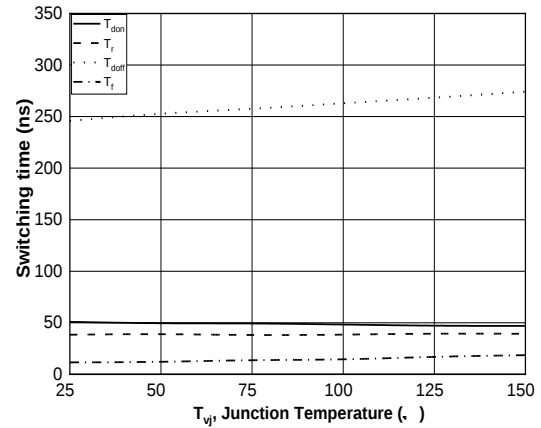


Figure 14. Typical switching times as a function of junction temperature

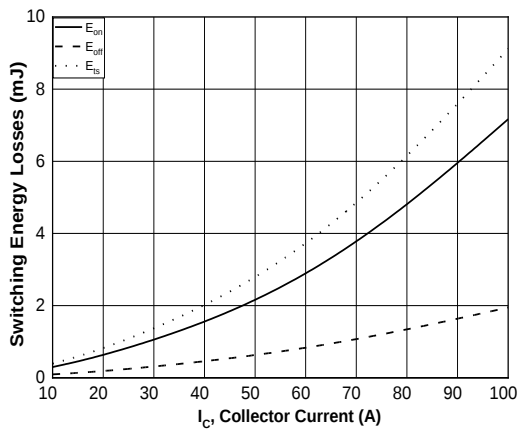


Figure 15. E_{on}, E_{off} as a function of I_C

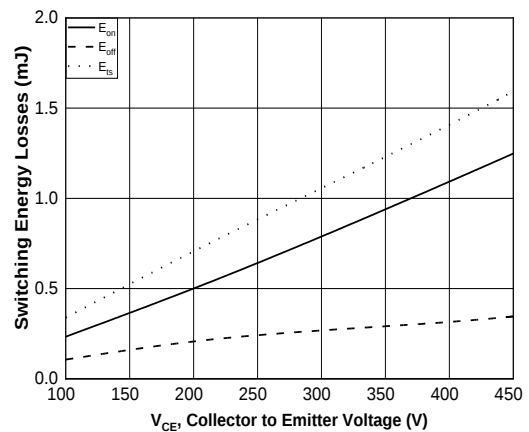


Figure 16. E_{on}, E_{off} as a function of V_{CE}

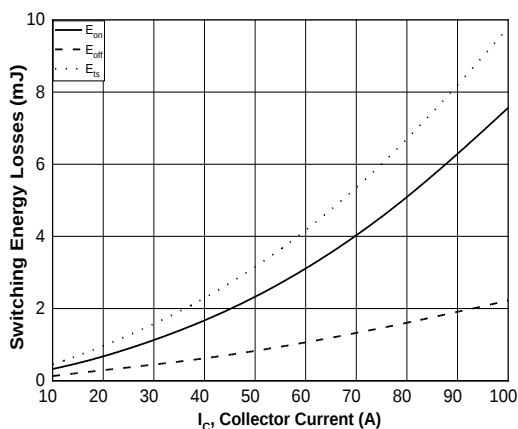


Figure 17. E_{on}, E_{off} as a function of I_C
(T_J=150°C, V_{CE}=400V, R_{G(on)}=R_{G(off)}=15Ω, V_{GE}=0/15V)

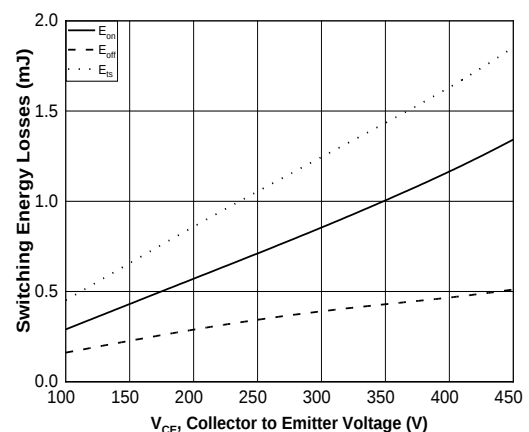


Figure 18. E_{on}, E_{off} as a function of V_{CE}
(T_J=150°C, I_C=32A, R_{G(on)}=R_{G(off)}=15Ω, V_{GE}=0/15V)



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➤ Typical Performance Characteristics (Tvj=25°C unless otherwise noted)

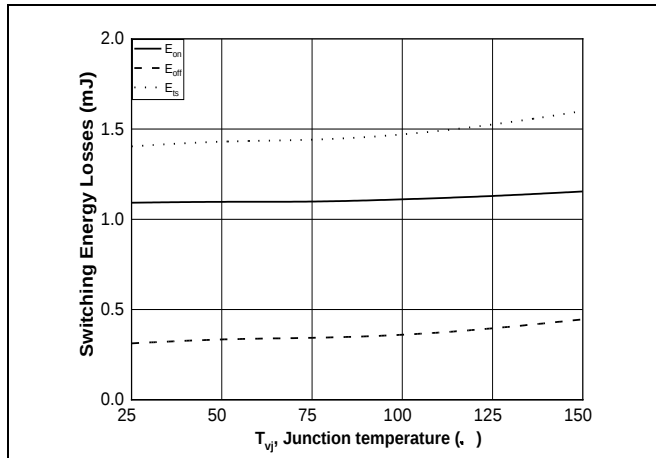


Figure 19. Eon Eoff as a function of junction temperature

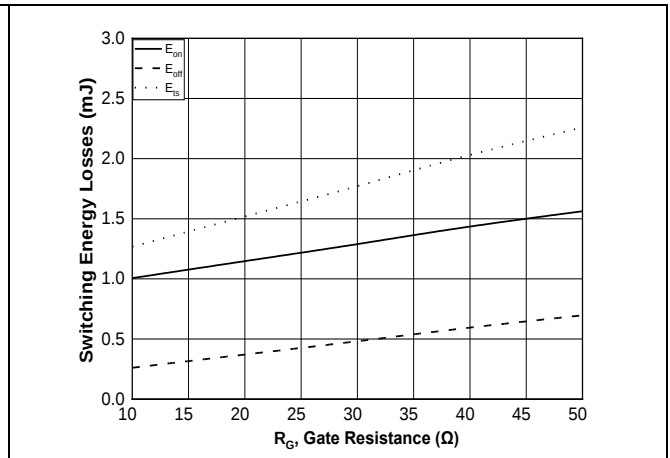


Figure 20. Eon Eoff as a function of gate resistance

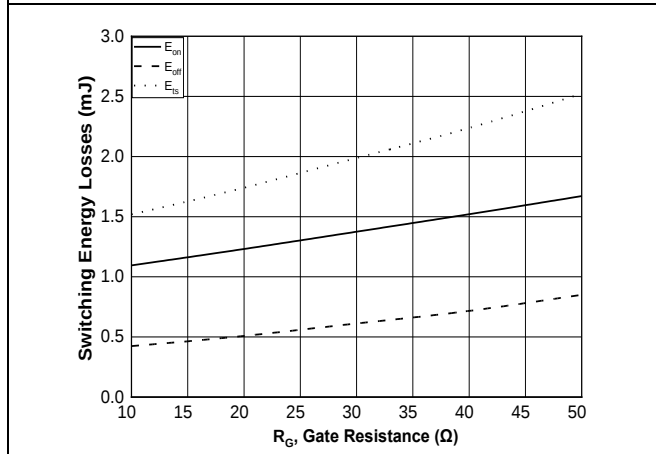


Figure 21. Eon Eoff as a function of gate resistance
(Tj=150°C, VCE=400V, IC=32A,
VGE=0/15V)

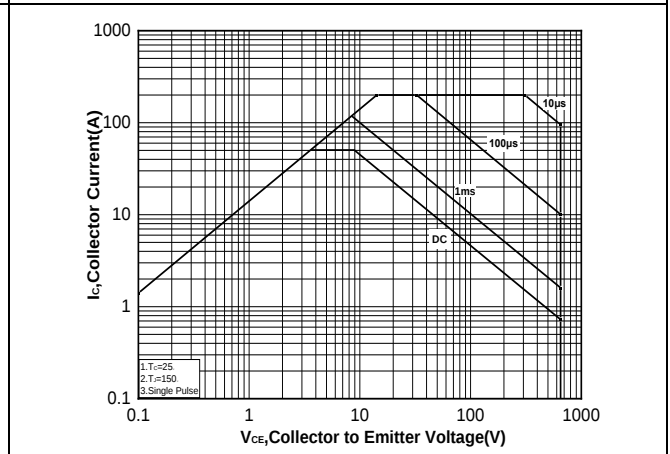


Figure 22. Forward bias safe operating area

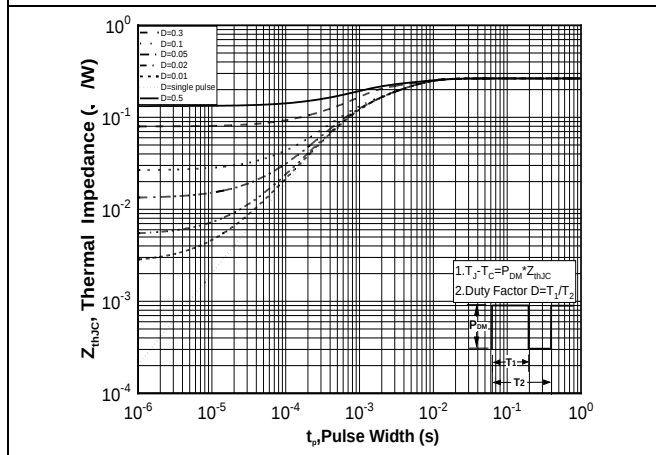


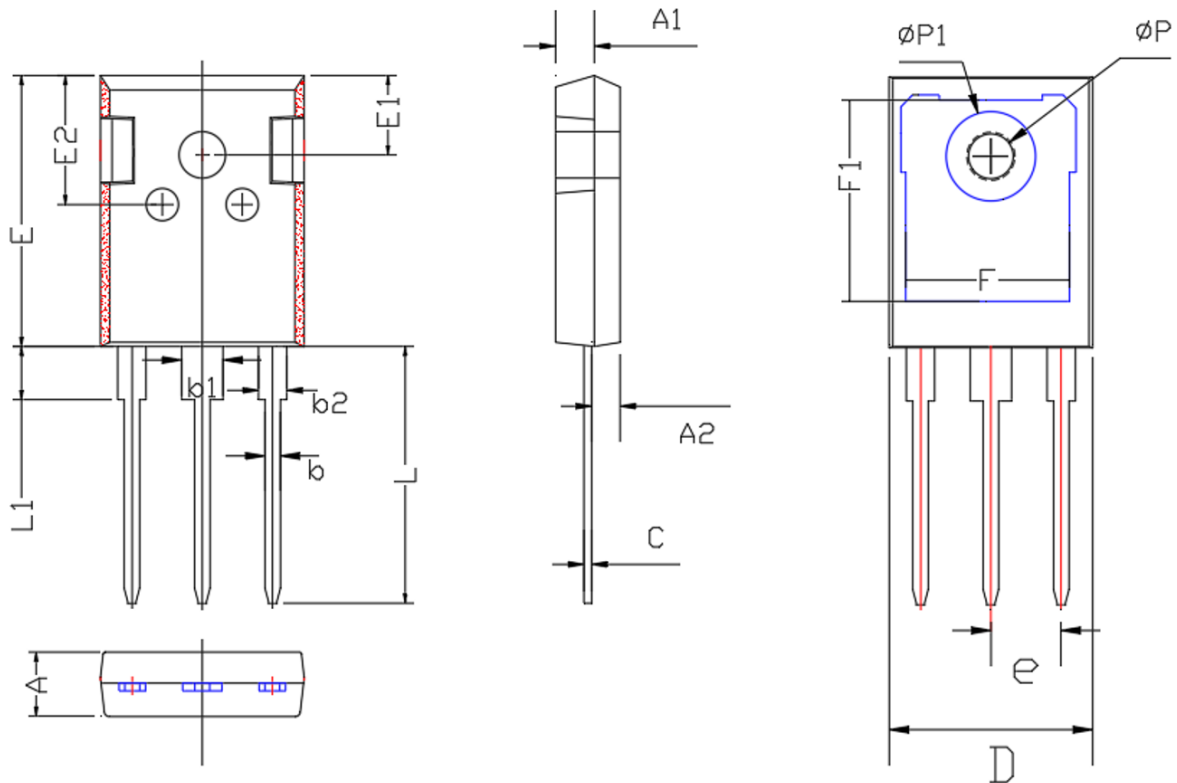
Figure 23. Transient thermal resistance



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➤ Package Information

TO247-3L



Symbol	MILL IMETER			Symbol	MILL IMETER		
	Min	Nom	Max		Min	Nom	Max
A	4.80	5.00	5.20	E1	5.60	5.80	6.20
A1	3.30	3.50	3.70	E2	9.8	10.0	10.2
A2	2.20	2.40	2.60	e	5.25	5.45	5.65
b	1.00	1.20	1.40	F	13.1	13.4	13.7
b1	2.90	3.10	3.30	F1	16.25	16.55	16.85
b2	1.90	2.10	2.30	L	19.5	20.0	20.5
c	0.50	0.60	0.71	L1	4.00	4.20	4.40
D	15.2	15.7	16.2	P	3.30	3.50	3.80
E	20.8	21	21.2	P1	6.80	7.10	7.40



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